



# Product Change Notification

Change Notification #: 117859 - 00

Change Title: Intel® Server Chassis H2224XXLR3, PCN 117859-00, Label, Intel® Power Supply Label Update and TA Label Orientation Change

Date of Publication: November 3, 2020

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: \* November 18, 2020

\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel® is updating the Intel® Power Supply FXX2130PCRPS Label and TA Label Orientation in Intel® Server Chassis H2224XXLR3.

## Power Supply Label Update:

Before:	After:

**Power Supply TA Label Orientation:**

**Before (Horizontal):**



**After (Vertical):**



**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
H2224XXLR3	948907	J57870-007	J57870-008

**PCN Revision History:**

Date of Revision:	Revision Number:	Reason:
November 3, 2020	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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